

Why Weibull continues to be foundation for modeling reliability.

The Weibull distribution is arguably the most important distribution in failure analysis of leaded and Pb-free solder joints. It is the first thought for someone trying to model thermal cycle, drop shock or other failure modes associated with through-hole and SMT assembly.

The Weibull distribution was *invented* by Waloddi Weibull in 1931. This invention fact was recounted by Dr. Robert Abernethy in his famous textbook on Weibull analysis:

The New Weibull Handbook

. This statement may not seem unusual, until we ponder that all common distributions in statistics were

discovered

, not invented. The three most common statistical distributions are the normal, poisson and binomial distributions. As an example of a discovered statistical distribution, let's consider the binomial distribution. This distribution describes, among other things, the odds in flipping a coin. If you flip a fair coin 60 times, you are most likely to obtain 30 heads (H) and 30 tails (T), but getting 29 H and 31 T or 32 H and 28 T would not be all that uncommon. Mathematical analysis shows that the curve in

Figure 1

results. If a coin flipping experiment is performed many times, this curve will faithfully predict the results. The curve is not invented; it is discovered from the deep theoretical underpinnings of the binomial distribution.

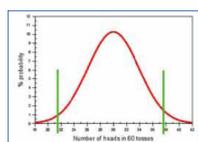


FIGURE 1. The likelihood of getting heads in 60 coin tosses is described by binomial distribution.

The fact that the Weibull distribution was invented suggests that Weibull selected it because it fit many types of failure data. He defined cumulative Weibull distribution as:

$$F(t) = 1 - e^{-(t/\eta)^\beta}$$

where eta is the characteristic life or the scale function, and beta is the slope, where as F(t) is the cumulative fraction of failures. Weibull proposed this function because for beta less than 1, F(t) describes “infant” mortality fails. In this situation, the failure rate is decreasing with time. For beta greater than 1, it describes “wear out” failures, where the failure rate is increasing with time. In electronics, we typically try to weed out infant mortality by using “burn in.” For beta equal to 1, the failure rate is constant. These three scenarios are shown in **Figure 2**. So

Electronics Failure Analysis for Pb- and Pb-Free Solder Joints

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typically, in electronics failure analysis, we are plotting failure data versus time to determine beta and eta, typically with software like Minitab.

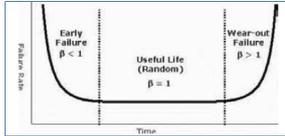


FIGURE 2. Weibull distribution showing various mortality rates for electronics.

Weibull himself was a curious character, and much of the available information on him is chronicled by Abernethy. For sure Weibull was a vigorous man. His second wife was almost 50 years his junior, and he fathered a daughter at about 80 years of age!

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